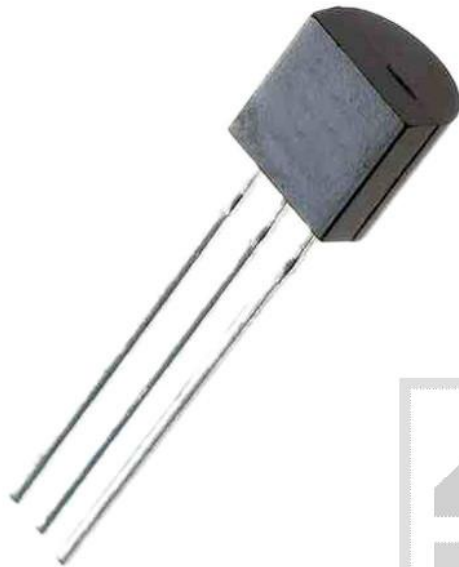




# Triak MAC97A8; Philips; 0.6A; 600V; 5mA TO92; przewlekany THT; RoHS



## Dane techniczne:

Nazwa: MAC97A8

Typ: Triak

Prąd przewodzenia: 0.6A

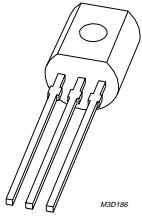
Napięcie wsteczne: 600V

Prąd bramki: 5mA

Obudowa: TO92

Montaż: THT

Producent: Philips



# MAC97A8; MAC97A6

Logic level triac

Rev. 01 — 29 March 2001

Product specification

## 1. Description

Logic level sensitive gate triac intended to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

Product availability:

MAC97A8 in SOT54 (TO-92)

MAC97A6 in SOT54 (TO-92) available on request - contact your sales representative.

## 2. Features

- Blocking voltage to 600 V (MAC97A8)
- RMS on-state current to 0.6 A
- Sensitive gate in all four quadrants
- Low cost package.

## 3. Applications

- General purpose bidirectional switching
- Phase control applications
- Solid state relays.

## 4. Pinning information

Table 1: Pinning - SOT54 (TO-92), simplified outline and symbol

Pin	Description	Simplified outline	Symbol
1	main terminal 2		
2	gate		
3	main terminal 1		

MSB0:  
SOT54 (TO-92)

## 5. Quick reference data

**Table 2: Quick reference data**

Symbol	Parameter	Conditions	Typ	Max	Unit
$V_{\text{DRM}}$	repetitive peak off-state voltage				
	MAC97A8	$T_j = 25$ to $125$ °C	–	600	V
	MAC97A6	$T_j = 25$ to $125$ °C	–	400	V
$I_{\text{T(RMS)}}$	on-state current (RMS value)	full sine wave; $T_{\text{lead}} \leq 50$ °C; <b>Figure 5</b>	–	0.6	A
$I_{\text{TSM}}$	non-repetitive peak on-state current		–	8.0	A

## 6. Limiting values

**Table 3: Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{\text{DRM}}$	repetitive peak off-state voltage				
	MAC97A8	$T_j = 25$ to $125$ °C	–	600	V
	MAC97A6	$T_j = 25$ to $125$ °C	–	400	V
$I_{\text{T(RMS)}}$	on-state current (RMS value)	full sine wave; $T_{\text{lead}} \leq 50$ °C; <b>Figure 5</b>	–	0.6	A
$I_{\text{TSM}}$	non-repetitive peak on-state current	full sine wave; $T_j = 25$ °C prior to surge			
		$t = 20$ ms	–	8.0	A
		$t = 16.7$ ms	–	8.8	A
$I^2t$	$I^2t$ for fusing	$t = 10$ ms	–	0.32	A <sup>2</sup> s
$di_T/dt$	repetitive rate of rise of on-state current after triggering	$I_{\text{TM}} = 1.0$ A; $I_G = 0.2$ A; $di_G/dt = 0.2$ A/ $\mu$ s			
		T2+ G+	–	50	A/ $\mu$ s
		T2+ G–	–	50	A/ $\mu$ s
		T2– G–	–	50	A/ $\mu$ s
		T2– G+	–	10	A/ $\mu$ s
$I_{\text{GM}}$	gate current (peak value)	$t = 2$ $\mu$ s max	–	1	A
$V_{\text{GM}}$	gate voltage (peak value)	$t = 2$ $\mu$ s max		5	V
$P_{\text{GM}}$	gate power (peak value)	$t = 2$ $\mu$ s max	–	5	W
$P_{\text{G(AV)}}$	average gate power	$T_{\text{case}} = 80$ °C; $t = 2$ $\mu$ s max	–	0.1	W
$T_{\text{stg}}$	storage temperature		–40	+150	°C
$T_j$	operating junction temperature		–40	+125	°C

## 7. Thermal characteristics

Table 4: Thermal characteristics

Symbol	Parameter	Conditions	Value	Unit
$R_{th(j-lead)}$	thermal resistance from junction to lead	full cycle	60	K/W
		half cycle	80	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	mounted on a printed circuit board; lead length = 4 mm; <b>Figure 1</b>	150	K/W

### 7.1 Transient thermal impedance

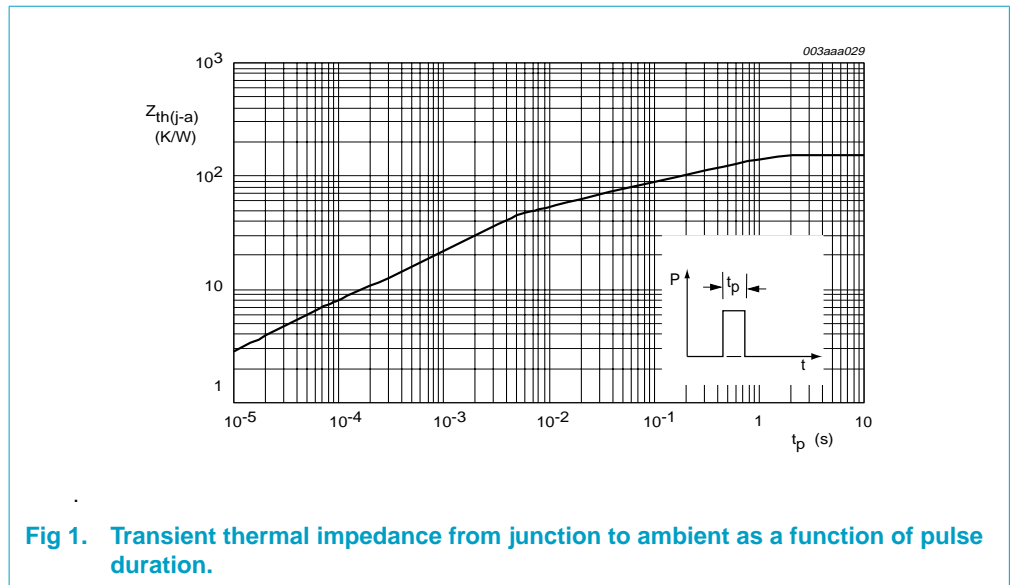


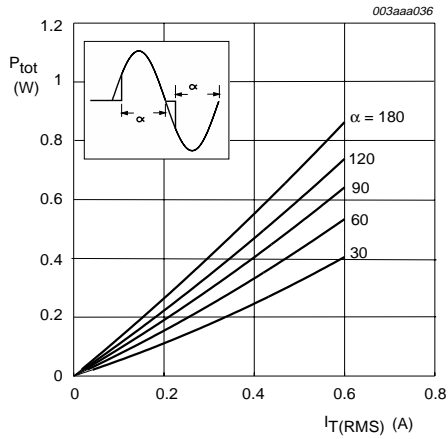
Fig 1. Transient thermal impedance from junction to ambient as a function of pulse duration.

## 8. Characteristics

**Table 5: Characteristics**

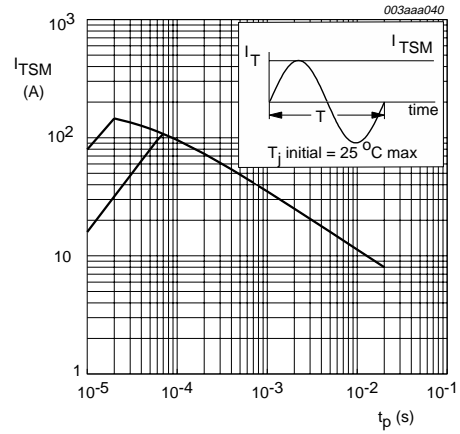
$T_j = 25\text{ °C}$  unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Static characteristics</b>						
$I_{GT}$	gate trigger current	$V_D = 12\text{ V}$ ; $I_T = 0.1\text{ A}$ ; <b>Figure 8</b>				
		T2+ G+	–	1	5	mA
		T2+ G–	–	2	5	mA
		T2– G–	–	2	5	mA
		T2– G+	–	4	7	mA
$I_L$	latching current	$V_D = 12\text{ V}$ ; $I_{GT} = 0.1\text{ A}$ ; <b>Figure 9</b>				
		T2+ G+	–	1	10	mA
		T2+ G–	–	5	10	mA
		T2– G–	–	1	10	mA
		T2– G+	–	2	10	mA
$I_H$	holding current	$V_D = 12\text{ V}$ ; $I_{GT} = 0.1\text{ A}$ ; <b>Figure 10</b>	–	1	10	mA
$V_T$	on-state voltage	$I_T = 0.85\text{ A}$ ; <b>Figure 11</b>	–	1.4	1.9	V
$V_{GT}$	gate trigger voltage	$V_D = 12\text{ V}$ ; $I_T = 0.1\text{ A}$ ; <b>Figure 7</b>	–	0.9	2	V
		$V_D = V_{DRM}$ ; $I_T = 0.1\text{ A}$ ; $T_j = 110\text{ °C}$	0.1	0.7	–	V
$I_D$	off-state leakage current	$V_D = V_{DRM(max)}$ ; $T_j = 110\text{ °C}$	–	3	100	$\mu\text{A}$
<b>Dynamic characteristics</b>						
$dV_D/dt$	critical rate of rise of off-state voltage	$V_D = 67\%$ of $V_{DM(max)}$ ; $T_{case} = 110\text{ °C}$ ; exponential waveform; gate open circuit; <b>Figure 12</b>	30	45	–	$\text{V}/\mu\text{s}$
$dV_{com}/dt$	critical rate of rise of commutation voltage	$V_D = \text{rated } V_{DRM}$ ; $T_{case} = 50\text{ °C}$ ; $I_{TM} = 0.84\text{ A}$ ; commutating $di/dt = 0.3\text{ A/ms}$	–	5	–	$\text{V}/\mu\text{s}$
$t_{gt}$	gate controlled turn-on time	$I_{TM} = 1.0\text{ A}$ ; $V_D = V_{DRM(max)}$ ; $I_G = 25\text{ mA}$ ; $di_G/dt = 5\text{ A}/\mu\text{s}$	–	2	–	$\mu\text{s}$



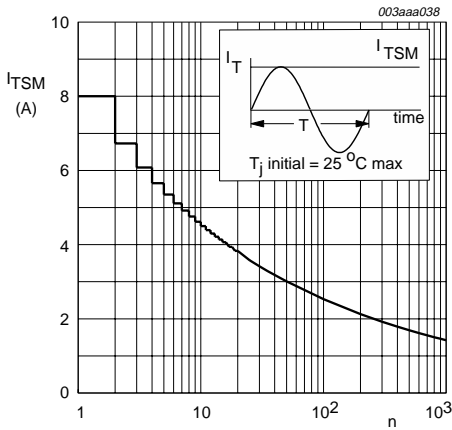
$\alpha$  = conduction angle

**Fig 2. Maximum on-state dissipation as a function of RMS on-state current; typical values.**



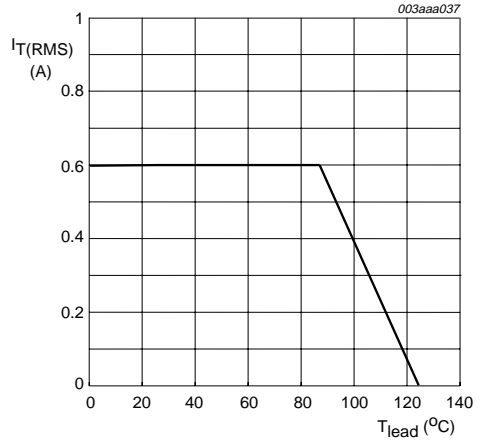
$t_p \leq 20$  ms

**Fig 3. Maximum permissible non-repetitive peak on-state current as a function of pulse width for sinusoidal currents; typical values.**

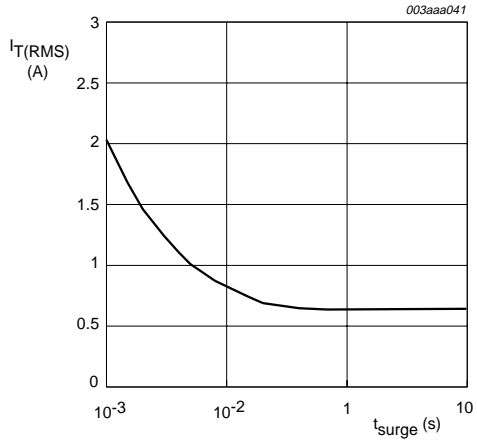


$n$  = number of cycles at  $f = 50$  Hz

**Fig 4. Maximum permissible non-repetitive peak on-state current as a function of number of cycles for sinusoidal currents; typical values.**

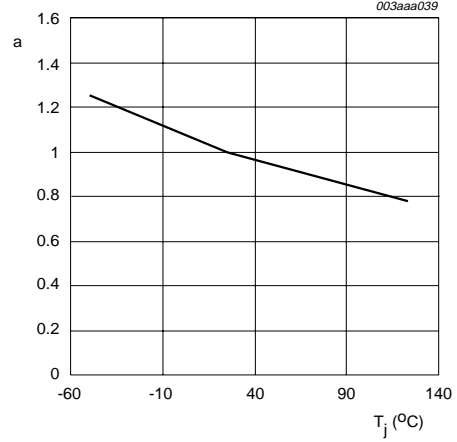


**Fig 5. Maximum permissible RMS current as a function of lead temperature; typical values.**



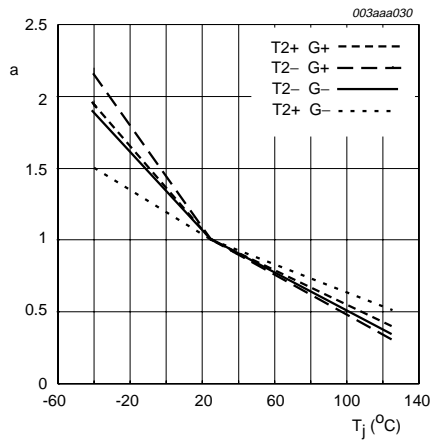
$f = 50 \text{ Hz}; T_{\text{lead}} \leq 50 \text{ }^\circ\text{C}$

**Fig 6. Maximum permissible repetitive RMS on-state current as a function of surge duration for sinusoidal currents; typical values.**



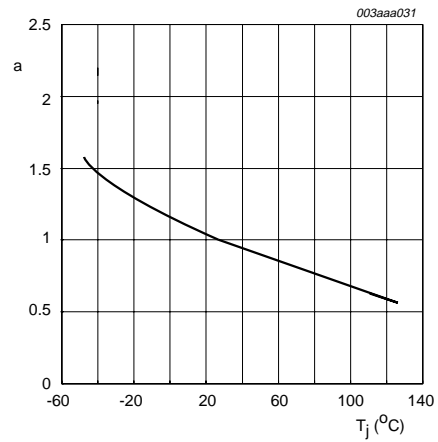
$$a = \frac{V_{GT(T_j)}}{V_{GT(25^\circ\text{C})}}$$

**Fig 7. Normalized gate trigger voltage as a function of junction temperature; typical values.**



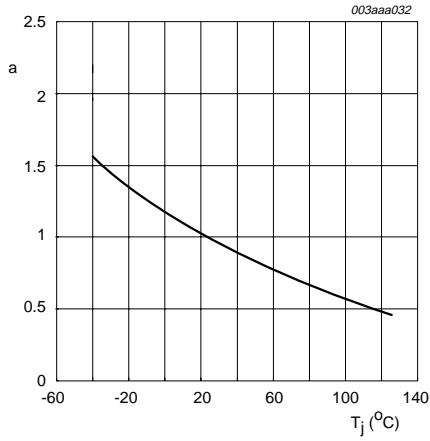
$$a = \frac{I_{GT(T_j)}}{I_{GT(25^\circ\text{C})}}$$

**Fig 8. Normalized gate trigger current as a function of junction temperature; typical values.**



$$a = \frac{I_{L(T_j)}}{I_{L(25^\circ\text{C})}}$$

**Fig 9. Normalized latching current as a function of junction temperature; typical values.**



$$a = \frac{I_{H(T_j)}}{I_{H(25^\circ\text{C})}}$$

Fig 10. Normalized holding current as a function of junction temperature; typical values.

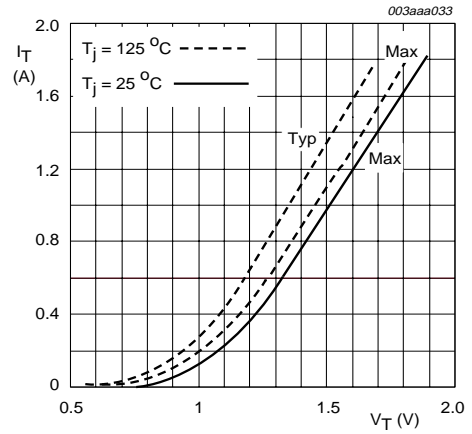


Fig 11. On-state current as a function of on-state voltage; typical and maximum values.

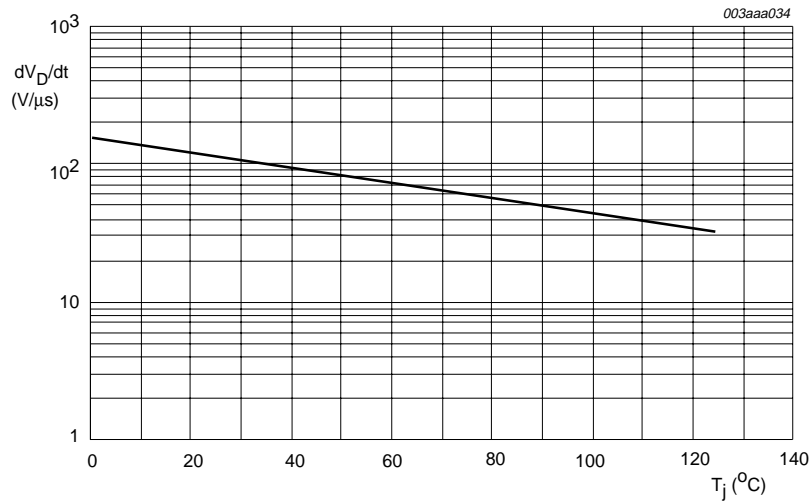


Fig 12. Critical rate of rise of off-state voltage as a function of junction temperature; typical values.



9. Package outline

Plastic single-ended leaded (through hole) package; 3 leads

SOT54

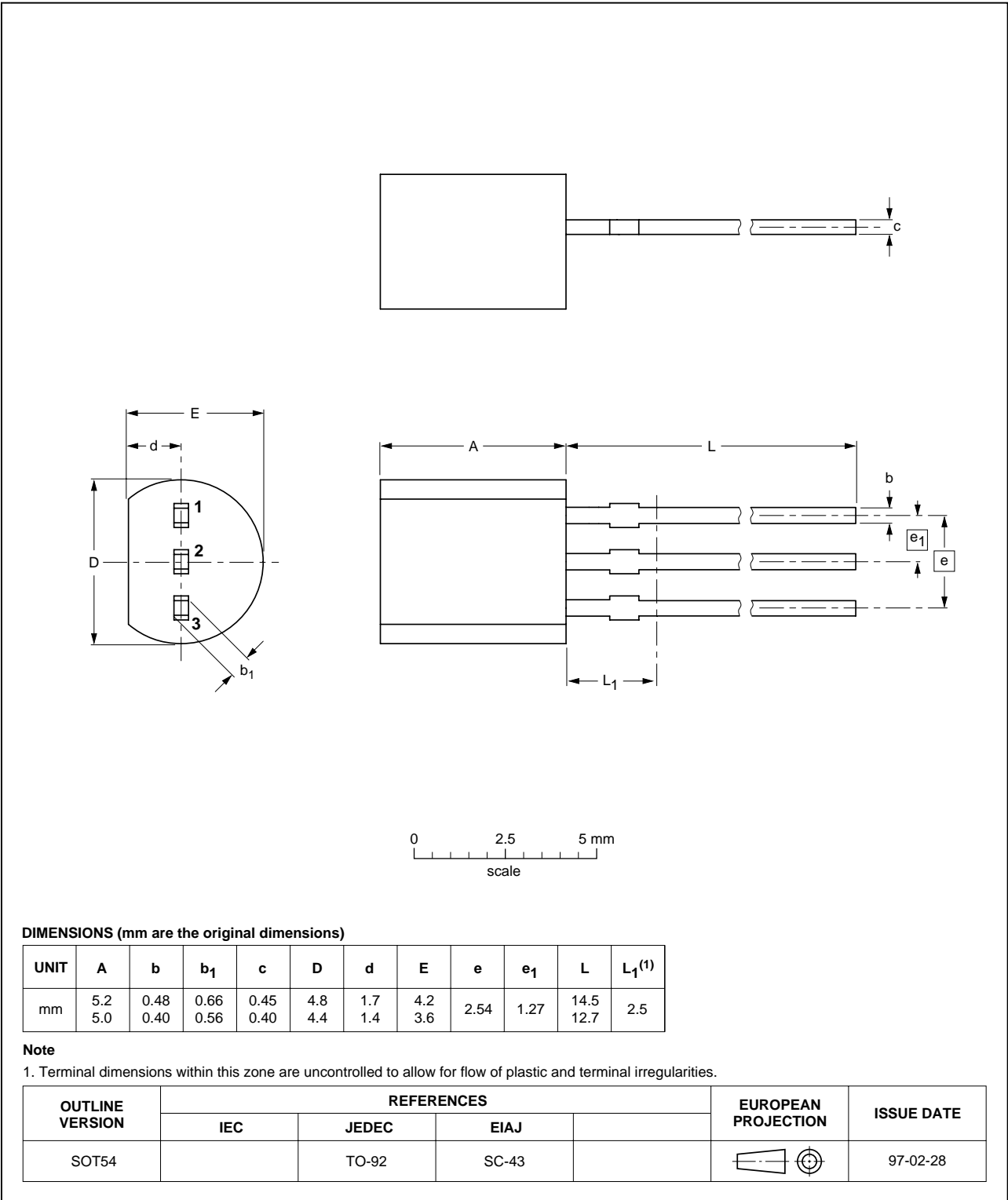


Fig 13. SOT54 (TO-92).

## 10. Revision history

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Table 6: Revision history

Rev	Date	GPCN	Description
01	20010329	-	Product specification; initial version

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## 11. Data sheet status

Data sheet status <sup>[1]</sup>	Product status <sup>[2]</sup>	Definition
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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[1] Please consult the most recently issued data sheet before initiating or completing a design.

[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL <http://www.semiconductors.philips.com>.

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**Limiting values definition** — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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